

IN THE CLAIMS:

Please amend claims as follows:

Claim 1 (Currently Amended): A method of fabricating ~~[[a]]~~ liquid crystal display panels
~~panel~~, comprising:

forming a plurality of ~~first substrates~~ upper liquid crystal display panel units having at least two different sizes on a first mother substrate and a plurality of ~~second substrates~~ lower liquid crystal display panel units having at least two different sizes on ~~first and~~ a second mother substrate ~~substrates, respectively;~~

forming sealant patterns on at least one of the mother substrates;

attaching the first and second mother substrates to each other to bond the upper liquid crystal display panel units with associated ones of the lower liquid crystal display panel units to form at least first and second liquid crystal display panel units;

forming at least first cutting lines on each of the first and second mother substrates, ~~wherein the first cutting lines line for separating a~~ corresponding to a boundary of the first unit liquid crystal display panel unit, wherein the first cutting lines extend over at least one sealant pattern;

forming at least second cutting lines on each of the first and second substrates, the second cutting lines corresponding to a boundary of the second liquid crystal display panel unit, which is larger than a second unit liquid crystal display panel separated by the second cutting line, and the first cutting line is extended to the sealant pattern; and

separating a plurality of the first and second unit liquid crystal display panel units into individual liquid crystal display panels,

wherein the first liquid crystal display panel unit is larger than the second crystal display panel unit ~~panels from the attached mother substrates; and~~
~~injecting a liquid crystal into the separated first and second unit liquid crystal panels.~~

Claim 2 (Original): The method according to claim 1, wherein the first and second mother substrates comprise a plurality of dummy glass substrates including main dummy glass substrates and secondary dummy glass substrates.

Claim 3 (Original): The method according to claim 2, wherein the secondary dummy glass substrates have a width of less than about 3 mm.

Claim 4 (Original): The method according to claim 1, wherein the sealant patterns are formed on non-display regions of the liquid crystal display panels.

Claim 5 (Original): The method according to claim 2, wherein the sealant patterns are positioned on both the main dummy glass substrates and the secondary dummy glass substrates.

Claim 6 (Currently Amended): The method according to claim 1, wherein sizes of the ~~first and second substrates~~ upper liquid crystal display panel units on the first mother substrate and the lower liquid crystal display panel units on the second mother substrate facing correspondingly at ~~into each other by attaching the first and second mother substrates~~ are substantially the same ~~with each other~~.

Claim 7 (Currently Amended): The method according to claim 1, wherein the ~~second substrates~~ lower liquid crystal display panel units have a plurality of thin film transistors and a plurality of pixel electrodes, and the ~~first substrates~~ upper liquid crystal display panel units have a plurality of color filters and a common electrode.

Claim 8 (Currently Amended): A method of fabricating [[a]] liquid crystal display panels ~~panel~~, comprising:

forming a plurality of ~~first substrates~~ upper liquid crystal panel units having at least two different sizes on a first mother substrate and a plurality of ~~second substrates~~ lower liquid crystal display panel units having at least two different sizes on ~~first and a second mother substrate~~ substrates, respectively;

forming sealant patterns on at least one of the mother substrates;

attaching the first and second mother substrates to each other to bond the upper liquid crystal display panel units with associated ones of the lower liquid crystal display panel units to form at least first and second liquid crystal display panel units;

forming at least first and second cutting lines on each of the first and second mother substrates; and

separating ~~a plurality of the~~ first and second ~~unit~~ liquid crystal display panel units ~~panels~~ from the attached mother substrates into individual liquid crystal display panel units having different sizes, wherein the ~~attached~~ separated mother substrates include main dummy glass substrates and secondary dummy glass substrates divided by the first and second cutting lines, and at least one of the sealant patterns are located ~~to be extended to~~ underneath the first cutting lines between the main dummy glass substrates and the secondary dummy glass substrates.

Claim 9 (Currently Amended): The method according to claim 8, further comprising injecting ~~[[a]] liquid crystal~~ crystals into the separated ~~unit~~ liquid crystal display panel units ~~panels~~.

Claim 10 (Original): The method according to claim 8, wherein the secondary dummy glass substrates have a width of less than about 3 mm.

Claim 11 (Currently Amended): The method according to claim 8, wherein sizes of the ~~first and second substrates~~ upper liquid crystal display panel units on the first mother substrate and the lower liquid crystal display panel units on the second mother substrate facing correspondingly at ~~into~~ each other ~~by attaching the first and second mother substrates~~ are substantially the same ~~with each other~~.

Claim 12 (Currently Amended): The method according to claim 8, wherein the ~~second substrates~~ lower liquid crystal display panel units have a plurality of thin film transistors and a plurality of pixel electrodes, and the ~~first substrates~~ upper liquid crystal display panel sections have a plurality of color filters and a common electrode.

Claim 13 (New): The method according to claim 1, further comprising injecting liquid crystals into the separated liquid crystal display panel units.

Claim 14 (New): The method according to claim 2, wherein at least one of the sealant patterns under the first cutting lines bind the main dummy glass substrates and secondary dummy glass substrates together during the separating step.

Claim 15 (New): The method according to claim 8, wherein at least one of the sealant patterns under the first cutting lines bind the main dummy glass substrates and secondary dummy glass substrates together during the separating step.